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Highly sensitive detection of NO₂ gas using BGaN/GaN superlattice-based double Schottky junction sensors

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We report a double Schottky junction gas sensor based on a BGaN/GaN superlattice and Pt contacts. NO₂ is detected at concentrations from 4.5 to 450 ppm with current responsivity of 6.7 mA/(cm² × ppm) at 250 °C with a response time of 5 s. The sensor is also selective against NH₃ at least for concentrations less than 15 ppm. The BGaN layer at the surface increases surface trap density and trap depth, which improves responsivity and high temperature stability while the GaN layer improves the magnitude of the diode current. The BGaN layer's columnar growth structure also causes a Pt morphology that improves O²⁻ diffusion. © 2015 AIP Publishing LLC.

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Nitride-based semiconductors are attractive materials for gas sensing applications due to their wide bandgap properties. Specifically, the high breakdown voltages and thermal stability of these materials make them suitable for high temperature applications in harsh environments (e.g., automotive exhaust systems or engines). Schottky diodes and metal-oxide-semiconductor field-effect transistor (MOSFET) devices using a variety of semiconductor materials have previously been demonstrated for detection of hydrogen and other gases,^{1–4} but their use for NO₂ sensing has not been widely explored. One potential application for NO₂ sensing is in the selective catalytic reduction of NO_x by injection of NH₃ in an automotive exhaust. Requirements for this application are high sensitivity and responsivity to the target gas, high thermal stability, and complete selectivity between NO_x and NH₃. The general mechanism of gas detection by Schottky diode sensors is attributed to the dissociation of gas molecules after physisorption on the catalytic Pt surface.⁵ The charged gas ions (negative oxygen ions in the case of NO₂) then diffuse through available grain boundaries or pores in the Pt contact and are chemisorbed at available interface traps on the semiconductor surface. The additional negative charge at the interface must be compensated by a more positive depletion region and an increase in the Schottky barrier height (SBH) $\Delta\phi_B = \frac{N_i\rho\theta}{\epsilon_0}$, where N_i is the interface trap concentration, ρ is the dipole moment between the gas and the traps, and θ is the fraction of interface traps occupied by gas ions.⁶ The increase of the SBH corresponds to a lowering of the device current. A second mechanism may also occur where the molecule or reaction intermediates interact either capacitively or directly with the interface traps via pores in the metal contact.⁸ Furthermore, the thickness and morphology of the contacts have been shown to affect gas sensitivity⁹ and are a possible strategy for selective detection of different species of gas. To analyze sensor

performance, one can measure the absolute current change, $\Delta I = |I_{gas} - I_0|$, or the relative sensitivity, $S = \frac{\Delta I}{I_0}$, where I_0 is the initial current when no gas is applied. In order to compare sensors that have different initial current values or measure different concentration ranges, we also can use the sensor responsivity $R = \frac{\Delta I}{area \times \Delta C}$, where ΔC is the change in concentration of gas. Schottky diode sensors based on 4H- and 6H-SiC with a thin Pt contact were shown to have a rather large value of $S = 19.35\%$ to 200 ppm NO₂ at 300 °C,⁷ but with a very low value of $R = 0.002$ mA cm⁻² ppm⁻¹ and slow response time, of the order of several minutes (see Table I). A separate study³ using n-type GaN Schottky diode sensors with a 75 nm-thick Pt contact showed an improved response to NO₂ at 300 °C compared to SiC-based sensors, but a quantitative comparison of the responsivity and/or sensitivity was not possible using the reported metrics. A Pt/AlGaN/GaN high electron mobility transistor (HEMT) structure was shown to exhibit a decreased $S = 10\%$ due to a higher initial current, but a significantly higher $R = 1.14$ mA cm⁻² ppm⁻¹ at 400 °C.⁸ This tradeoff between the ΔI (and thus the responsivity) and sensitivity is explained by the fact that the ΔI for Schottky diodes is given by the expression $\Delta I = I_0(e^{\frac{\Delta\phi_B}{kT}} - 1)$, which is derived from the thermionic emission transport model. Therefore, a high initial current results in high responsivity whereas the sensitivity is increased with a large increase in $\Delta\phi_B$ caused by a high concentration of interface traps, which results in a lowering of the initial current. Finding a balance between ΔI and I_0 is exemplified by the work of Quang *et al.*¹⁰ who reached large ΔI while maintaining relatively large I_0 in SNO₂ nanowires-based Schottky junction (SJ) gas sensor, and thus resulting in outstanding values of both sensitivity and responsivity (see Table I). Furthermore, even if limited to very low gas concentration (tens of ppb) and rather low operating temperature (150 °C), the response time (τ_r) of the device was shown to be relatively fast at

TABLE I. Comparison of NO₂ sensor performances, including sensitivity (S), responsivity (R), response time (τ_r), and recovery time (τ_R).

Device	Catalyzer	I_0 (mA)	ΔI (μ A)	S (%)	R ($\frac{\text{mA}}{\text{cm}^2 \times \text{ppm}}$)	T ($^{\circ}$ C)	τ_r/τ_R (s)	Reference
SiC Schottky diode	Pt	0.002	0.38	19.35	0.002	300	90/120	7
SNO ₂ Schottky diode	...	0.42	243	58.3	≤ 648	150	43/37	10
AlGaIn/GaN HEMT	Pt	5	500	10	1.43	400	n/a	8
GaN Schottky diode	20 nm Pt	11.5	370	3.2	1.14	200	300/300	This work
BGaN/GaN SL MSM	100 nm Pt	7.07	2140	30	6.7	250	5/80	This work
		± 0.3	± 105	± 1.5	± 0.3			

43 s with a recovery time (τ_R) of 37 s. Finally, Schottky sensors for NH₃ detection have also been reported,¹¹ but complete selectivity between NO_x and NH₃ has not yet been demonstrated with these types of devices.

In this work, we report double SJ NO₂ sensors based on GaN materials that exhibit large sensitivity and responsivity with tunable electrical conductivity (to adjust I_0) and carrier trapping efficiency (to adjust $\Delta\phi_B$ and thus ΔI). To achieve this, quasi-alloys of BGaN/GaN superlattices (SLs) were used as active layers. Indeed, we have shown previously that the electrical conductivity of the BGaN alloy can be tuned over more than seven orders of magnitude using low boron incorporation concentration (less than 2%).¹² Furthermore, we have also shown^{13,14} an enhancement of the $\Delta\phi_B$ originating from an increase of the trapping efficiency due to boron incorporation in the BGaN quasi-alloy. BGaN/GaN SL structures allow more flexibility in the tuning of the boron incorporation in thick layers compared to BGaN monolayers.¹⁵ We also choose to use a double SJ metal-semiconductor-metal (MSM) design that is more simple to fabricate compared to Schottky diode or HEMT structure. The performance of this device for NO₂ detection is compared to double SJ Pt/GaN reference devices that we have fabricated and other reported Schottky and HEMT devices for NO₂ detection.

The reference device used in this work is a commercially available 400 nm thick n-type GaN (Si-doped). The BGaN/GaN SL structure was grown using 10 periods of 20 nm thick undoped GaN and 20 nm thick BGaN with an average boron concentration of the quasi-alloy of 3.6%. The structure was grown and processed according to the procedure given by Srour *et al.*¹³ Another device was processed with 20 nm Pt using the same conditions on the n-type GaN sample. The circular diodes have a 300 μ m diameter with a 200 μ m spacing between the two Pt contacts (see Fig. 1(a)).

For experimental testing, the devices were connected with probes in a gas chamber and connected to a Keithley 236 IV measurement system. Gas sources of pure N₂ and 450 ppm NO₂ with pressure regulators were connected to the testing chamber via a gas blender so that the pressure, concentration, and flow rate were all controlled during the measurements. A flow rate of 100 sccm was used for all measurements.

The ΔI and S of the GaN and BGaN/GaN SL devices upon exposure to 450 ppm NO₂ gas are shown as a function of temperature in Fig. 1(b).

For the BGaN/GaN SL device with 100 nm thick Pt layer, a ΔI of 215 μ A and S of 12% were obtained at 25 $^{\circ}$ C, compared to 14 μ A and 0.1%, respectively, for the GaN device with a 20 nm thick Pt layer. It is important to note that the GaN device with a Pt thickness of 100 nm showed no

sensitivity or current change with gas exposure, likely due to a continuous Pt layer with no grain boundaries for oxygen diffusion as shown by scanning electron microscopy (SEM) images of the device surfaces (not shown).

For both samples, the ΔI and S are shown to increase with temperature. In the case of the BGaN/GaN SL device, the measured values of ΔI fluctuate slightly, which is probably due to motion of the contact point of the electrical probe tips, observed with increasing the temperature. This did not occur with GaN devices which were wire-bonded to the contact pad. Nevertheless, according to these results, the ΔI and S of the BGaN/GaN SL device are significantly higher than both the GaN reference device and the devices reported in literature (see Table I), reaching values of 2140 μ A and 30%, respectively, at 250 $^{\circ}$ C. This means that the BGaN superlattice structure offers a good balance for high S and ΔI , whereas other devices show a significant tradeoff between the two metrics. The improved sensitivity of the BGaN/GaN SL sensor can be explained by a combination of two mechanisms.

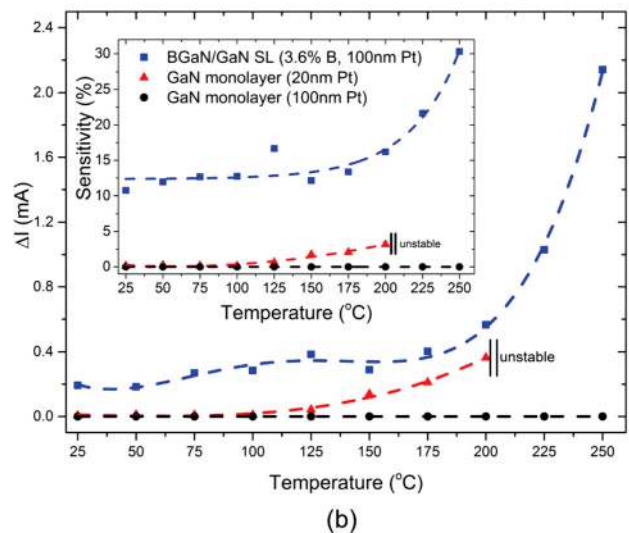
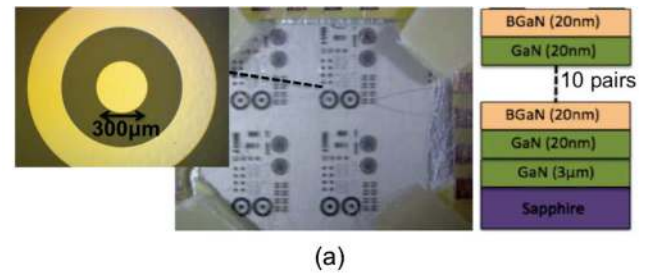


FIG. 1. (a) Sensor device and (b) comparison of the temperature dependence of ΔI and S (inset) of BGaN/GaN SL and GaN sensors to 450 ppm NO₂ at 5 V bias.

The first is that BGaN material has more interface traps than GaN and thus more adsorption sites for the oxygen ions. This results in more gas coverage at the interface and a larger SBH change. The secondary advantage of the BGaN layer is that it exhibits columnar growth, decreasing the volume-to-area ratio at the interface. This means that it is possible to have more interface traps within a given area. Additionally, the columnar surface of BGaN causes the Pt layer to have more grain boundaries, increasing the diffusion of the oxygen ions through the Pt contact to the interface traps. Furthermore, ΔI is not sacrificed due to the higher-conductivity GaN interlayers in the superlattice structure, which serve to increase the I_0 . This leads to both high responsivity and sensitivity to NO_2 for the BGaN/GaN SL sensor, with a responsivity of $6.7 \pm 0.3 \text{ mA cm}^{-2} \text{ ppm}^{-1}$ at 250°C , as shown in Table I. This is significantly higher than the responsivity for other reported devices except the SNO_2 nanowires-based SJ gas sensor.

For all samples tested, we found that there was a memory effect after gas exposure and that it was necessary to reset the sensor by increasing the temperature and purging the test chamber between each measurement. Temperatures of 100°C and 300°C were required to reset the GaN and BGaN/GaN SL samples, respectively. This result is consistent with chemisorption at the interface as the mechanism responsible for the SBH change. Chemisorption requires the additional energy present at higher temperatures in order for desorption to break the bonds of absorption. Deep-level transient spectroscopy (DLTS) measurements, not shown here, indicate that electron traps in BGaN material become deeper with boron incorporation, which can explain the higher reset temperature required for the BGaN/GaN SL sensor. It is to be noticed that the GaN sensor becomes unstable above 200°C (see Fig. 1(b)) due to a drift in baseline current, making it impossible to take a reliable measurement at these temperatures. The cause of this drift is currently being explored, but may be due to the thin Pt layer used. After returning to temperatures below 200°C , the baseline remains stable.

To further analyze the thermal stability of the devices, measurements were taken as a function of applied bias at 150°C . In SJ device gas sensor, in opposite to S which is only a function of the change in SBH and is expected to remain constant after a steady state value is obtained, ΔI and R are proportional to I_0 and thus their values should increase with increasing bias voltage. The dependence of ΔI and S on applied bias is shown for the BGaN/GaN SL and GaN sensors at 150°C (Fig. 2). As expected, ΔI increases with increasing bias voltage up to 5 V for both devices (see inset), but S reaches a constant value only for the BGaN/GaN SL device and bias larger than 2 V. On the contrary, the GaN sensor exhibits a maximum S followed by a decrease at higher voltages. This decrease could be attributed to a temperature-dependent avalanche effect that is proportional to the initial current.¹⁶ Under high electric fields, there is an increase in tunneling through the barrier and a reduction of the effective barrier height. This additional tunneling current diminishes the effect of the increase in barrier height due to the gas, thereby reducing the sensitivity. At 150°C , BGaN does not exhibit the same avalanche effect due to a lower initial current and therefore does not exhibit the loss in sensitivity at increased voltages as does GaN at the same temperature. This

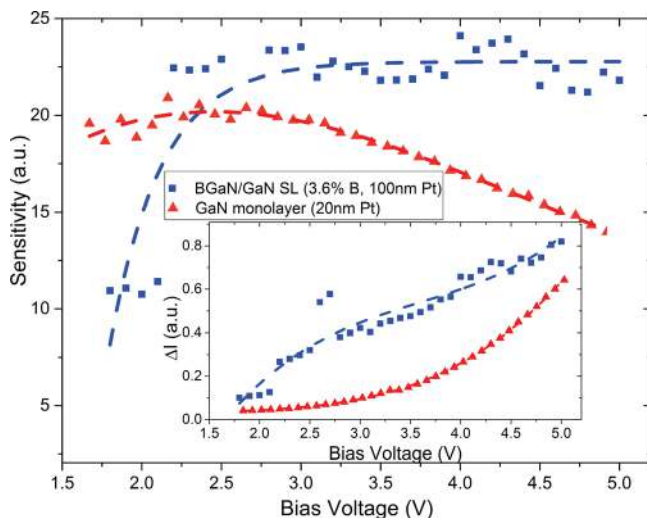


FIG. 2. ΔI and S of the BGaN/GaN SL and GaN sensors in 450 ppm NO_2 as a function of applied bias at 150°C . Values are given in arbitrary units so that the trends can be placed on the same scale.

result further demonstrates the improved thermal stability of the BGaN sample compared to GaN.

The evolution of the electrical current for the BGaN/GaN SL sensors under intermittent flows of 450 ppm NO_2 and pure N_2 gas at 300°C and 5 V bias is exemplified in Fig. 3. The signal for the BGaN/GaN SL device is shown to decrease to a steady-state value under NO_2 proportional to the concentration, and to recover to the initial value under a flow of pure N_2 . The response time, τ_r , was measured by allowing the signal to reach steady state under NO_2 and calculating the time between 10% and 90% of the steady state value. At 300°C , the response time was 5 s for the BGaN/GaN SL device and was indeterminable for the GaN device due to the instability at this temperature. Measurements at 150°C showed response time for the GaN device on the order of a few minutes. The full recovery time, τ_R , for the BGaN/GaN SL device was measured to be 80 s at 300°C .

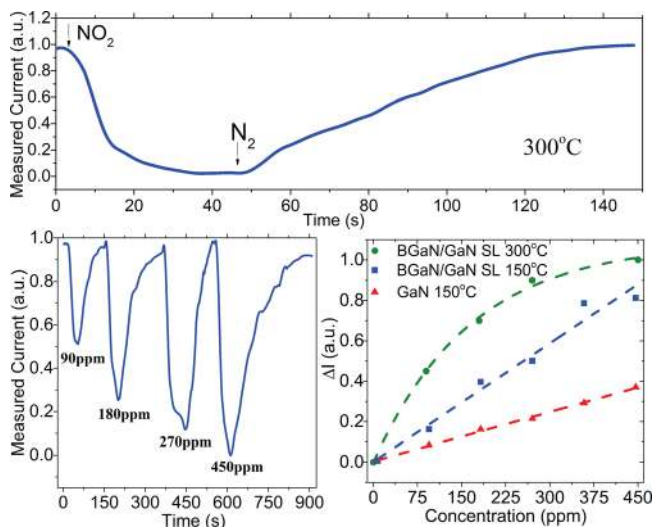


FIG. 3. Measured current (in arbitrary units) for the BGaN/GaN SL sensors under intermittent flows of 450 ppm NO_2 and pure N_2 gas at 300°C and 5 V bias (top), repeated between 90 and 450 ppm NO_2 (bottom left), and ΔI as a function of concentration for various temperatures, showing a linear response below 300°C (bottom right).

The measurement was repeated with varying NO₂ concentrations from 90 to 450 ppm at 300 °C, showing that the ΔI is a function of the concentration of gas (see bottom left of Fig. 3). We notice that at different concentrations, the recovery time is not always the same. This could be due to a difference in trap energies affecting the chemisorption of the gas. At this temperature, we begin to see saturation of the signal change leading to a nonlinear response for the BGaN/GaN SL as a function of concentration, whereas it remains linear at 150 °C for both the BGaN/GaN SL and GaN monolayer devices (see bottom right of Fig. 3). This means that at higher temperatures and concentrations, it is possible to have a decrease in the responsivity of the device.

Finally, the BGaN/GaN SL device was tested in 15 ppm of NH₃, and showed no current change under the applied gas even at a temperature of 250 °C. In contrast, we measured 0%–2% sensitivity to 0–15 ppm NO₂ at the same temperature, indicating that the BGaN/GaN SL device shows a very good selectivity between NH₃ and NO₂ at this concentration range. This has not yet been demonstrated by other SJ or MOSFET sensor devices. The GaN device was not responsive to 15 ppm of either NO₂ or NH₃, most likely because this concentration of NO₂ is below the detection limit of GaN sensor. We are currently investigating this phenomenon for other gases and concentration ranges as part of a separate study. The selectivity for the BGaN/GaN SL device may be attributed to a different detection mechanism for NH₃. One possible mechanism predicts that NH₃ dissociation occurs most readily at triple points where the Pt, semiconductor, and gas are all in contact simultaneously.⁹ Typically, these triple points require pores in the Pt layer; however, in the BGaN/GaN SL device no pores can be observed due to the thick Pt contacts. Instead, we only see grain boundaries which allow O₂ ion diffusion, but not NH₃ dissociation/diffusion. Therefore, we may be able to alter the Pt thickness or morphology to obtain sensitivity to NH₃ in addition to NO₂, as well as further selectivity between different gases. This is currently being investigated.

In conclusion, we have shown that SJ gas sensors based on a BGaN/GaN SL structure exhibit high responsivity and a good balance between responsivity and sensitivity. At the

same time, the sensitivity of the BGaN/GaN SL sensor is also significantly higher, making it the best choice for balancing the responsivity and sensitivity. This means that the BGaN/GaN SL sensor can be operated at a target detection limit while maintaining a higher signal-to-noise ratio (SNR) compared to the other sensors. Additionally, the BGaN/GaN SL sensor shows better thermal stability and a faster response time than the GaN-based sensor, and the ability to selectively detect between NH₃ and NO₂.

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